

Irradiation test on FD-SOI Readout ASIC of Pair-monitor for ILC

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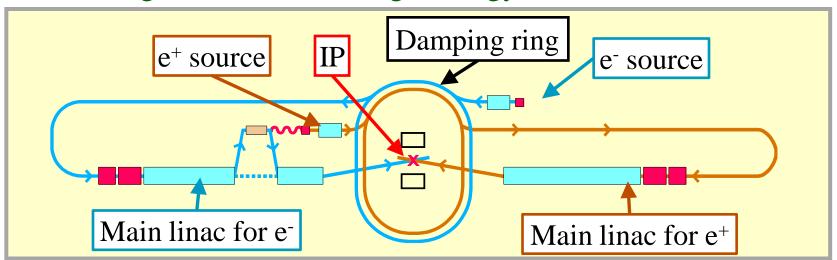
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International Linear Collider

ILC is a next generation of the high-energy e⁺ e⁻ collider.



Purposes

- Study higgs sector
- Search new physics

Parameters

- CM energy: 500 GeV (upgrade to 1 TeV)
- Integrated luminosity (4 years): 500 fb-1
- Beam size

$$(\sigma_x, \sigma_v, \sigma_z) = (639 \text{ nm}, 5.7 \text{ nm}, 300 \text{ }\mu\text{m})$$

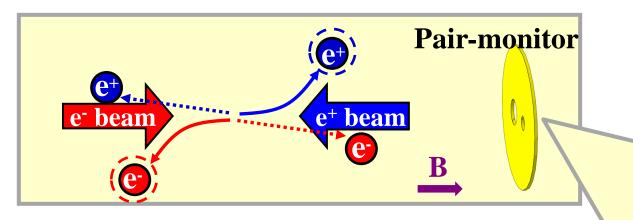
→ Beam Profile monitor is necessary to keep the high luminosity.



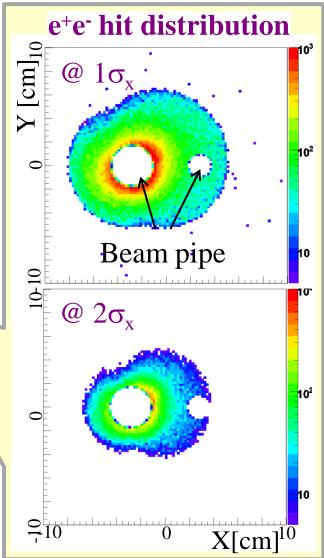
Pair-monitor

Pair-monitor is a silicon pixel detector to measure the beam profile at IP.

- The distribution of the pair B.G. is used.
 - The same charges with respect to the oncoming beam are scattered with large angle.
 - The scattered particles have information on beam shape.



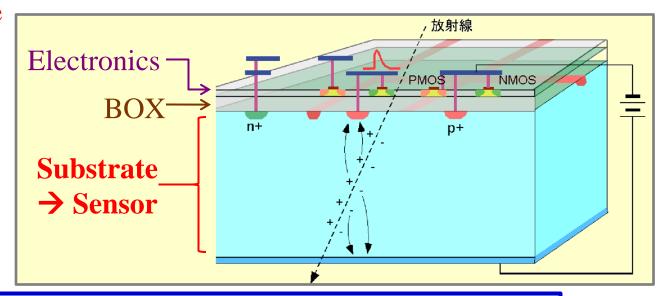
The beam size can be derived from the pair B.G. distribution.



The pair-monitor is developed using the SOI technology.

SOI (Silicon On Insulator) pixel detector

- SOI pixel group at KEK is currently developing.
- The sensor and electronics are integrated in a SOI wafer.
 - Monolithic device
 - High speed
 - Low power
 - > Thin device
 - Low material



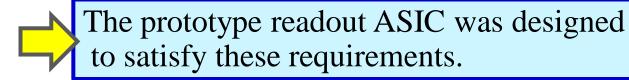
- The prototype ASIC for the pair-monitor was fabricated via the MPW Run organized by the SOI pixel group.
- This prototype is not monolithic (Substrate is not a sensor).

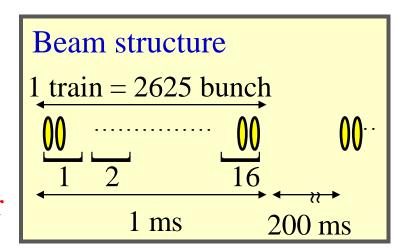
Requirement to readout ASIC

Required performance

- 1. Time resolution : < 260 nsec
 - (less than bunch space)
- 2. Noise level : < 1000 e

 (typical signal level : 15,000 e)
- 3. Radiation tolerance : > a few Mrad/year
- 4. Time-dependent measurement
 - Measure the pixel hit count in 16 time slice per train,
 and hit counts are read out during the inter-train gap of 200 ms.





Prototype readout ASIC

Analogue circuit

Comparator

8 bit counter

• Process : FD-SOI CMOS 0.20 μm

Offset voltage

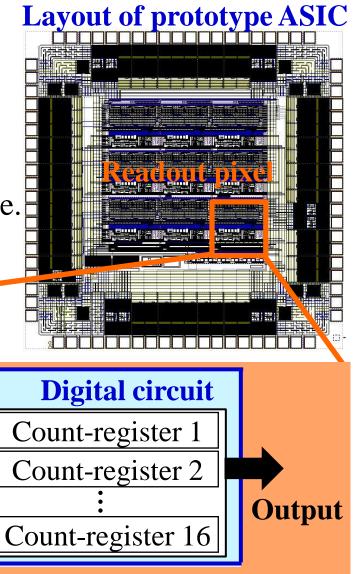
trimming circuit

- Chip size : 2.5 x 2.5 mm²
- # of pixels : 9 (3x3)

Input

Amp.

- Pixel size : 390 x 350 μm²
- Each pixel has different detector capacitance.



Irradiation test

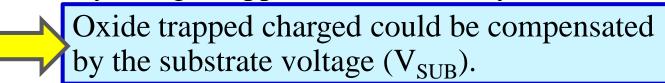
Irradiation test was performed to test the radiation tolerance

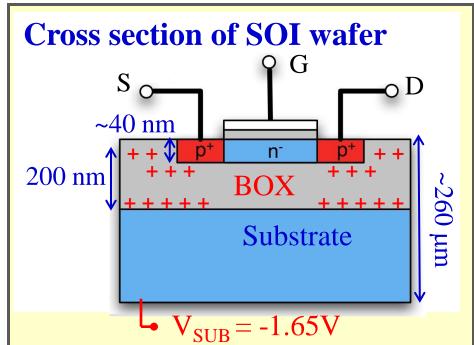
and observe the radiation effect.

- X-ray generator : Rigaku FR-D
 - Target : Cu (~ 8 keV photon)
- Doses: up to 2 Mrad

Radiation effect

- Single event effect (SEE)
 - Caused by single energetic particle.
 - → SOI device is known as rad-hard for SEE
- Total dose effect (TDE)
 - Caused by charge trapped in the oxide layer.

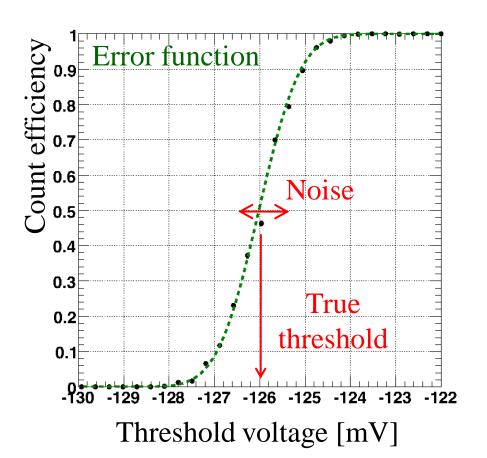


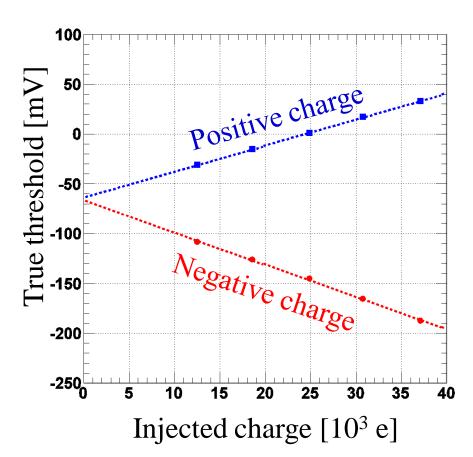


(design value)

Measurements

- Signal shape at pre-amplifier
- Gain
- Linearity
- Noise level

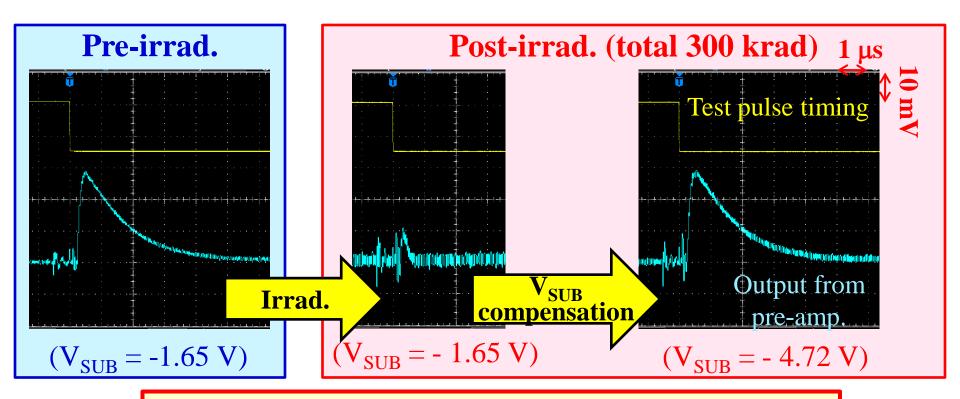




Signal shape

The signal shape at the pre-amp. was compared.

• By irradiation, the signal shape becomes smaller and vanished at the post-irrad. of larger 1 Mrad.

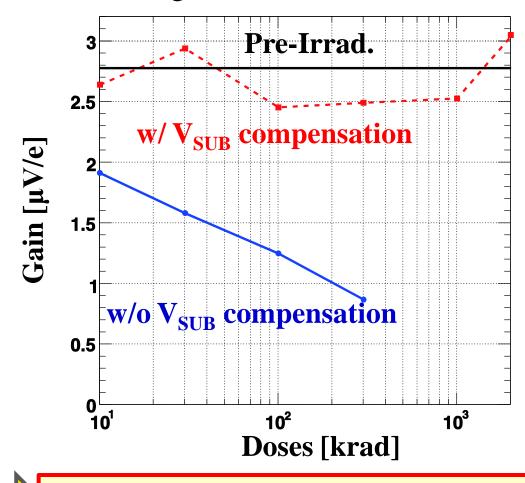


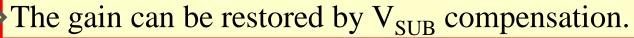
The signal shape of post-irradiation can be returned to that of pre-irradiation by V_{SUB} compensation.

Gain

The gain was compared.

• By the irradiation, the gain becomes smaller.



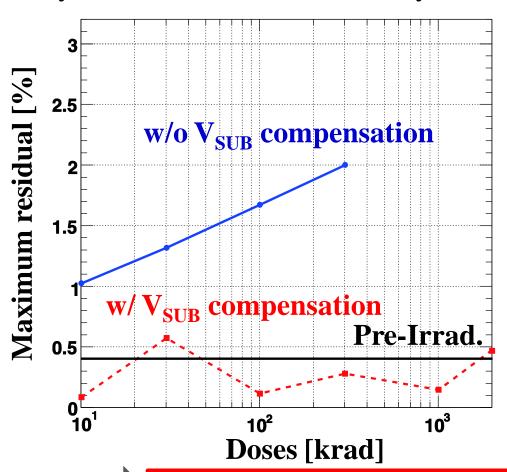


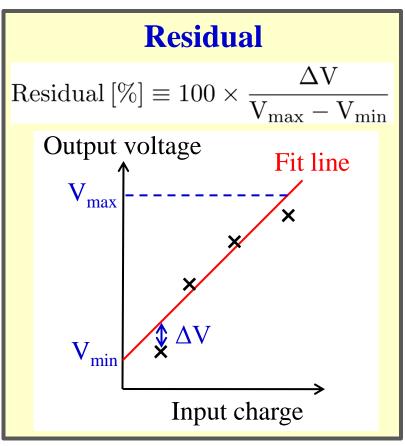
Linearity

The linearity was compared.

(fitting region : $7,000 \sim 45,000 e$)

• By the irradiation, the linearity becomes worse.



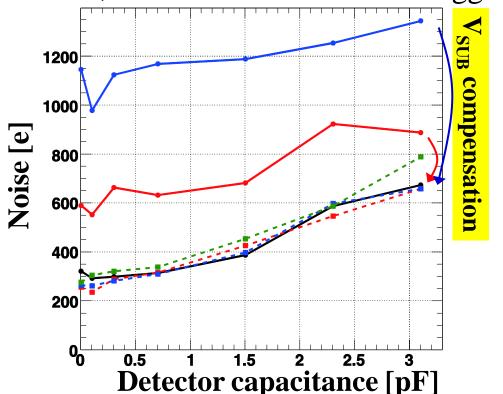


The linearity can be restored by V_{SUB} compensation.

Noise level

The noise level was compared.

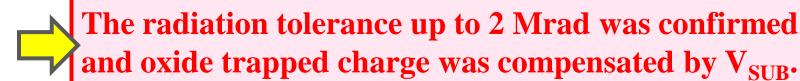
• By irradiation, the noise level becomes bigger.



Pre-Irrad.
Post-Irrad. (100krad)
Post-Irrad. (300krad)
Post-Irrad. (2Mrad)

★ Dashed line means w/ V_{SUB} compensation.

The noise level returns to that of pre-irrad. by the V_{SUB} compensation.



Summary

Pair-monitor is a silicon pixel detector to measure the beam profile at IP and developed with SOI technology.

- The first prototype which is only readout ASIC was produced and the irradiation test was performed successfully.
 - > The radiation tolerance up to 2 Mrad was confirmed.
 - ➤ The oxide trapped charge was compensated by the substrate voltage.

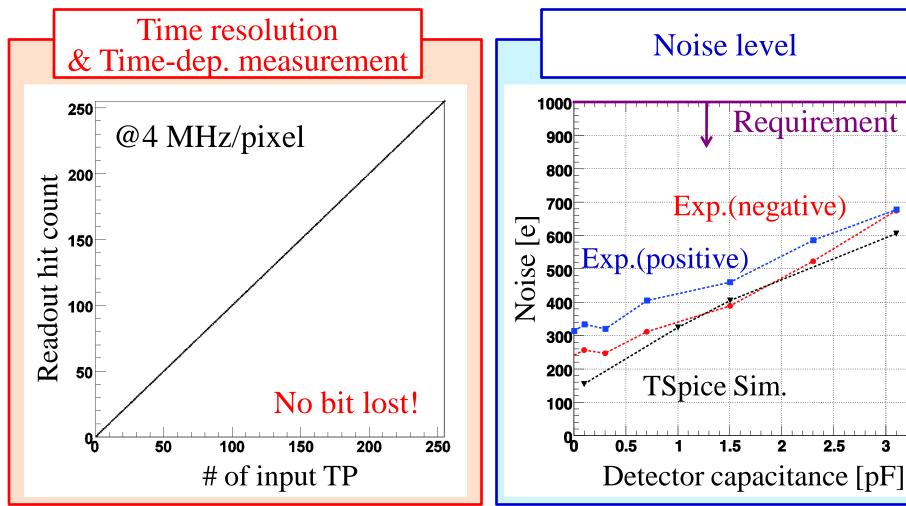
Plan

- Investigation into the next prototype
 - Monolithic or hybrid?

Backup

Operation test

Operation test was performed successfully.



Prototype meets the requirement of time resolution, time-dependent measurement and noise level.

Radiation doses

Total Doses = (#photon) × (**Doses per a photon**)

The number of photons

- Evaluated by the photoelectron of diode.
 - $k = 2.5 \times 10^9 [photon/\mu A]$

Doses per a photon

- Energy of photon: 8.19 keV
 - Weighted average of K α (8.04 keV) and K β (8.91 keV)
 - All the photons are assumed to be absorbed within an attenuation

length ($\lambda \sim 66 \mu m$)

• Silicon density $d = 2.33 \text{ g/cm}^3$



Voltage of substrate voltage (V_{SUB})

